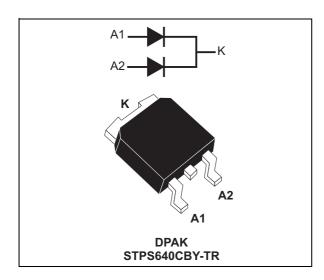
STPS640C-Y



Automotive power Schottky rectifier

Datasheet - production data



Features

- Low forward voltage drop
- Very small conduction losses
- Negligible switching losses
- · Extremely fast switching
- Low thermal resistanceAEC-Q101 qualified.

Description

This dual Schottky rectifier is designed for switch mode power supplies and other power converters.

This device is intended for use in low and medium voltage operation, and in particular high frequency circuits where low switching losses are required (free wheeling and polarity protection) in automotive applications.

Table 1. Device summary

| Symbol | Value |
|----------------------|---------|
| I _{F(AV)} | 2 x 3 A |
| V _{RRM} | 40 V |
| T _j | 150 °C |
| V _{F (Typ)} | 0.50 V |

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Table 2. Absolute ratings (limiting values, per diode)

| Symbol | Parameter | Value | Unit | |
|---------------------|--|------------|------|----|
| V _{RRM} | Repetitive peak reverse voltage | | | V |
| I _{F(RMS)} | Forward rms current | | 6 | Α |
| | per diode | | 3 | Α |
| ^I F(AV) | Average forward current, $\delta = 0.5$, $T_c = 135$ °C | per device | 6 | |
| I _{FSM} | Surge non repetitive forward current $t_p = 10 \text{ ms sinusoidal}, T_c = 25 \text{ °C}$ | | | Α |
| I _{RRM} | Peak repetitive reverse current $t_p = 2 \mu s$, $F = 1 kHz$ | | | Α |
| P _{ARM} | Repetitive peak avalanche power $t_p = 1 \mu s, T_c = 25 ^{\circ}C$ | | | W |
| T _{stg} | Storage temperature range | | | °C |
| Tj | Operating junction temperature | | | °C |

Table 3. Thermal parameters

| Symbol | Parameter | Value | Unit | |
|----------------------|---------------------------|-------|------|------|
| D | Junction to case per diod | е | 5.5 | |
| R _{th(j-c)} | per devi | се | 3 | °C/W |
| R _{th(c)} | coupling | | 0.5 | |

When the diodes 1 and 2 are used simultaneously : $\Delta Tj(\mbox{diode 1})$ = P(diode1) x R_{th(j-c)}(Per diode) + P(diode 2) x R_{th(c)}

Table 4. Static electrical characteristics (per diode)

| Symbol | Parameter | Test conditions | | Min. | Тур | Max. | Unit |
|--|---|-------------------------|----------------------|------|------|------|------|
| I _R ⁽¹⁾ Revers | Poverse leakage current | T _j = 25 °C | $V_R = V_{RRM}$ | - | - | 100 | μΑ |
| 'R` | I _R ⁽¹⁾ Reverse leakage current | T _j = 125 °C | | - | 2 | 10 | mA |
| | V (2) Farward voltage drap | T _j = 25 °C | I _F = 3 A | - | - | 0.63 | V |
| V _F ⁽²⁾ | | T _j = 125 °C | | - | 0.50 | 0.57 | |
| V _F ⁽²⁾ Forward voltage drop | T _j = 25 °C | I 6 A | - | - | 0.84 | V | |
| | | T _j = 125 °C | I _F = 6 A | - | 0.67 | 0.72 | |

^{1.} Pulse test: $t_p = 5$ ms, $\delta < 2\%$

To evaluate the conduction losses use the following equation:

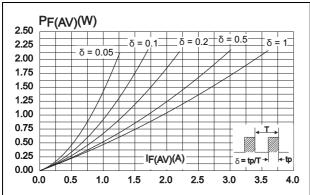
$$P = 0.42 \times I_{F(AV)} + 0.050 \times I_{F^{2}(RMS)}$$

^{2.} Pulse test: $t_p = 380 \mu s$, $\delta < 2\%$

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Figure 1. Average forward power dissipation versus average forward current (per diode)

Figure 2. Average forward current versus ambient temperature (δ = 0.5, per diode)



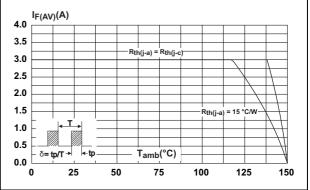
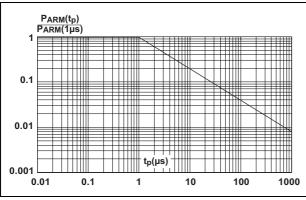


Figure 3. Normalized avalanche power derating versus pulse duration versus junction temperature



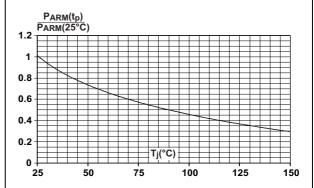
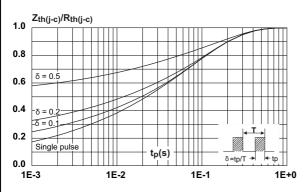
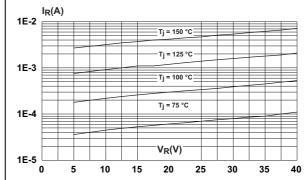


Figure 5. Relative variation of thermal impedance junction to case versus pulse duration

Figure 6. Reverse leakage current vs. reverse voltage applied (typical values, per diode)

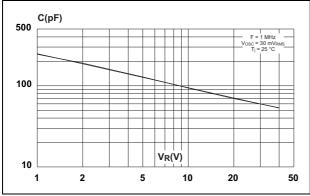




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Figure 7. Junction capacitance vs. reverse voltage applied (typical values, per diode)

Figure 8. Forward voltage drop vs. forward current (per diode)



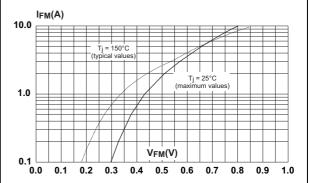
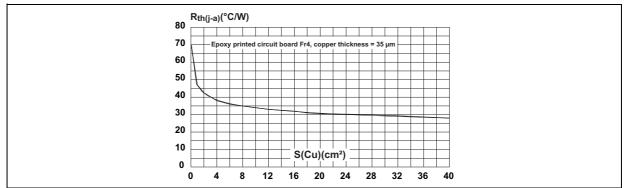


Figure 9. Thermal resistance junction to ambient versus copper surface under tab



2 Package information

- Epoxy meets UL94,V0
- Lead-free packages

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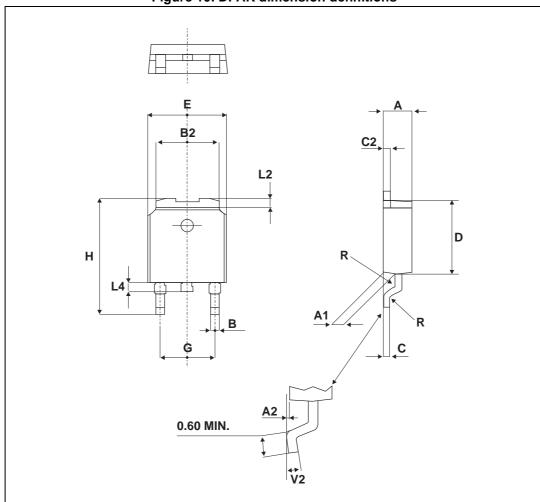


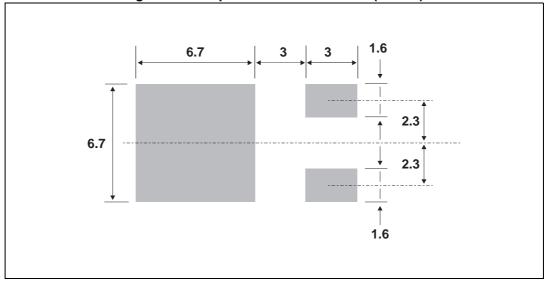
Figure 10. DPAK dimension definitions

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Table 5. DPAK dimension values

| | | | Dimens | ions | | | | |
|------|-------------|-----------|--------|-------|------------|--------|--|--|
| Ref. | Millimeters | | | | | Inches | | |
| | Min. | Тур. | Max. | Min. | Тур. | Max. | | |
| Α | 2.20 | | 2.40 | 0.086 | | 0.094 | | |
| A1 | 0.90 | | 1.10 | 0.035 | | 0.043 | | |
| A2 | 0.03 | | 0.23 | 0.001 | | 0.009 | | |
| В | 0.64 | | 0.90 | 0.025 | | 0.035 | | |
| B2 | 5.20 | | 5.40 | 0.204 | | 0.212 | | |
| С | 0.45 | | 0.60 | 0.017 | | 0.023 | | |
| C2 | 0.48 | | 0.60 | 0.018 | | 0.023 | | |
| D | 6.00 | | 6.20 | 0.236 | | 0.244 | | |
| Е | 6.40 | | 6.60 | 0.251 | | 0.259 | | |
| G | 4.40 | | 4.60 | 0.173 | | 0.181 | | |
| Н | 9.35 | | 10.10 | 0.368 | | 0.397 | | |
| L2 | | 0.80 typ. | | | 0.031 typ. | | | |
| L4 | 0.60 | | 1.00 | 0.023 | | 0.039 | | |
| V2 | 0° | | 8° | 0° | | 8° | | |

Figure 11. Footprint dimensions in mm (inches)



3 Ordering information

Table 6. Ordering information

| Order code | Marking | Package Weight | | Base qty | Delivery mode |
|---------------|-----------|----------------|-------|----------|---------------|
| STPS640CBY-TR | STPS640CY | DPAK | 0.3 g | 2500 | Tape and reel |

4 Revision history

Table 7. Revision history

| Date | Revision | Changes |
|-------------|----------|--|
| 6-Nov-2013 | 1 | First issue |
| 04-Dec-2013 | 2 | Properties changed from preliminary data to production data. |

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